



Material Content Data Sheet



Halogen-Free

Sales Product Name	IRF630NPBF	Issued	09. February 2022
MA#	MA005589986		
Package	PG-TO220-3-62	Weight*	1843.36 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.718	0.26	0.26	2560	2560
leadframe	inorganic material	phosphorus	7723-14-0	0.411	0.02		223	
	non noble metal	iron	7439-89-6	1.371	0.07		744	
	non noble metal	copper	7440-50-8	1,369.454	74.28	74.37	742911	743878
wire	non noble metal	aluminium	7429-90-5	2.208	0.12	0.12	1198	1198
encapsulation	organic material	carbon black	1333-86-4	2.257	0.12		1225	
	plastics	epoxy resin	-	90.289	4.90		48981	
	inorganic material	silicondioxide	60676-86-0	358.900	19.47	24.49	194699	244905
leadfinish	non noble metal	tin	7440-31-5	8.222	0.45	0.45	4460	4460
solder	non noble metal	tin	7440-31-5	0.111	0.01		60	
	noble metal	silver	7440-22-4	0.138	0.01		75	
	non noble metal	lead	7439-92-1	5.279	0.29	0.31	2864	2999
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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